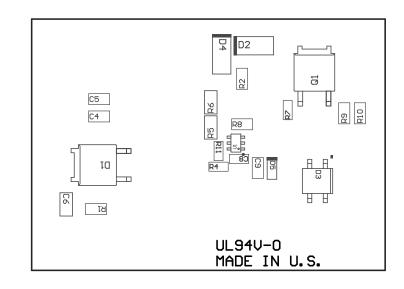


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP10276	REV: B	SUN REV:	Not In VersionControl
IGNORE -> Top Overlay				
PLOT NAME = Top Assembly Drawing	GENERATED : 5/28/2	2015 10: 42: 53	AM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP10276	REV: B	SUN REV:	Not In VersionControl
	Bottom Overlay <- JACONDI			
PLOT NAME = Bottom Assembly Drawing	GENERATED : 5/28/2	2015 10:42:53	AM AM	TEXAS INSTRUMENTS

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